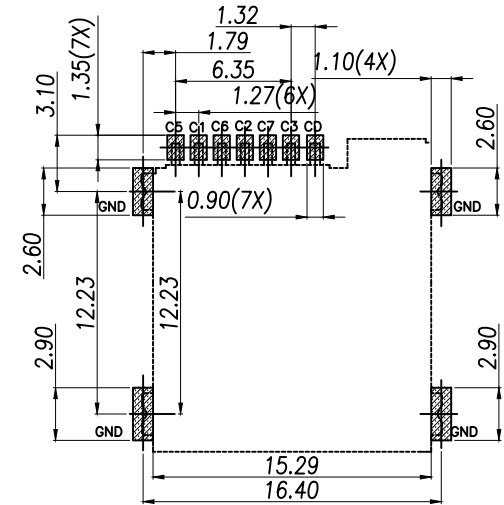
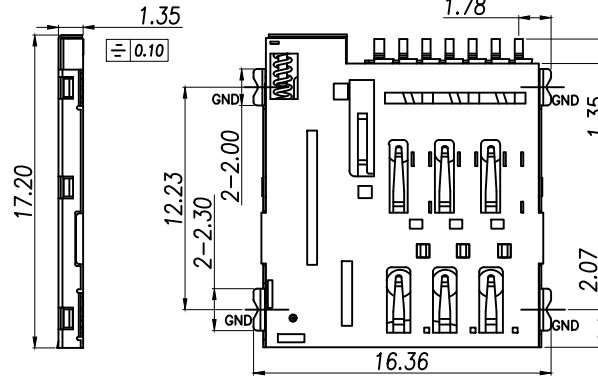
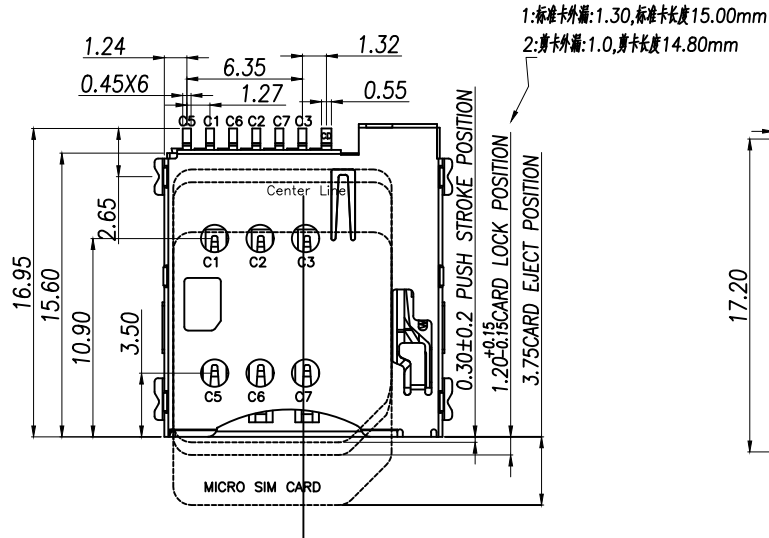


**MATERIAL:**

INSULATOR: HIGH TEMPERATURE THERMOPLASTIC, UL 94V-0
CONTACT: COPPER ALLOY
SHELL: SUS

PLATING:

CONTACT: PLATED 50U" NI OVER ALL CONTACT AU 1U
SHELL: PLATED 50U" NI OVERALL
PLATED 1U" AU SELECTIVE CONTACT AREA

ELECTRICAL:

CURRENT RATING: 0.5AMPS MAX
VOLTAGE RATING: 5V AC/DC
AMBIENT TEMPERATURE RANGE: -40℃ ~ +85℃
STORAGE TEMPERATURE RANGE: -40℃ ~ +85℃
AMBIENT HUMIDITY RANGE: 95% R.H. MAX.
CONTACT RESISTANCE: 100M MAX.Ω
INSULATION RESISTANCE: 1000M MIN./500VDCΩ
REFLOW PEAK TEMP: 260℃
MATING CYCLES: 5000MIN INSERTIONS

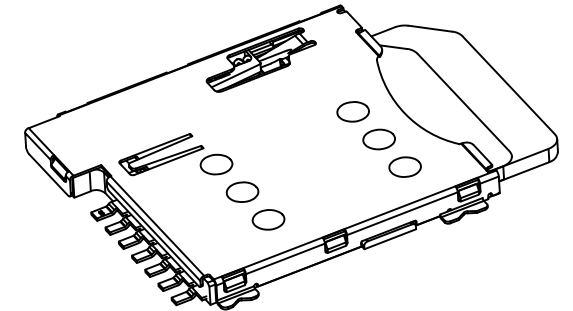
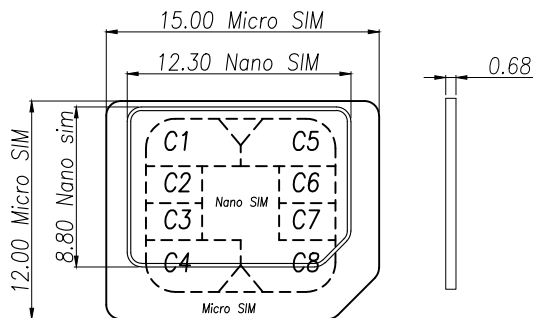
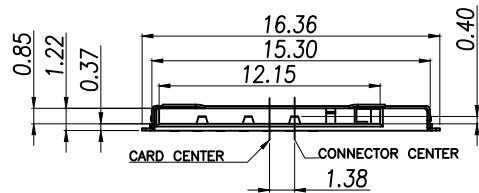
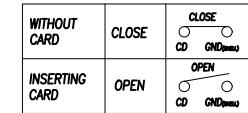
PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

Circuit Diagram for Detect Switch

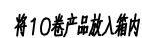


MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
CD	DETECTION SWITCH

DIMENSION IN mm	
TOLERANCE UNLESS OTHERWISE SPECIFIED	
.X±0.35	X.*±5°
.XX±0.25	.X.*±3°
.XXX±0.15	.XX.*±1°

厦门市辛译精密电子有限公司
Xiamen XinYi Xyconn Electronics Co.,Ltd

APR.	Alex	TITLE: MICRO SIM CARD PUSH PUSH 6+1PIN H1.35	
CHK.	Jack	DWG NO. MICRO SIM 7Pin 1.35h	
DRA.	Can	CUSTOMER DRAWING	
SIZE	A4	SCALE	1:1
SHEET	1/1	REV.	A



DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±0.35	X.*± 5°	APR. Alex	TITLE: MICRO SIM CARD PUSH PUSH 6+1PIN H1.35		
.XX±0.25	.X*± 3°	CHK. Jack	DWG NO. MICRO SIM 7Pin 1.35h		
.XXX±0.15	.XX*± 1°	DRA. Can	PROJ. 		CUSTOMER DRAWING
			SIZE A4	SCALE 1:1	SHEET 1/1